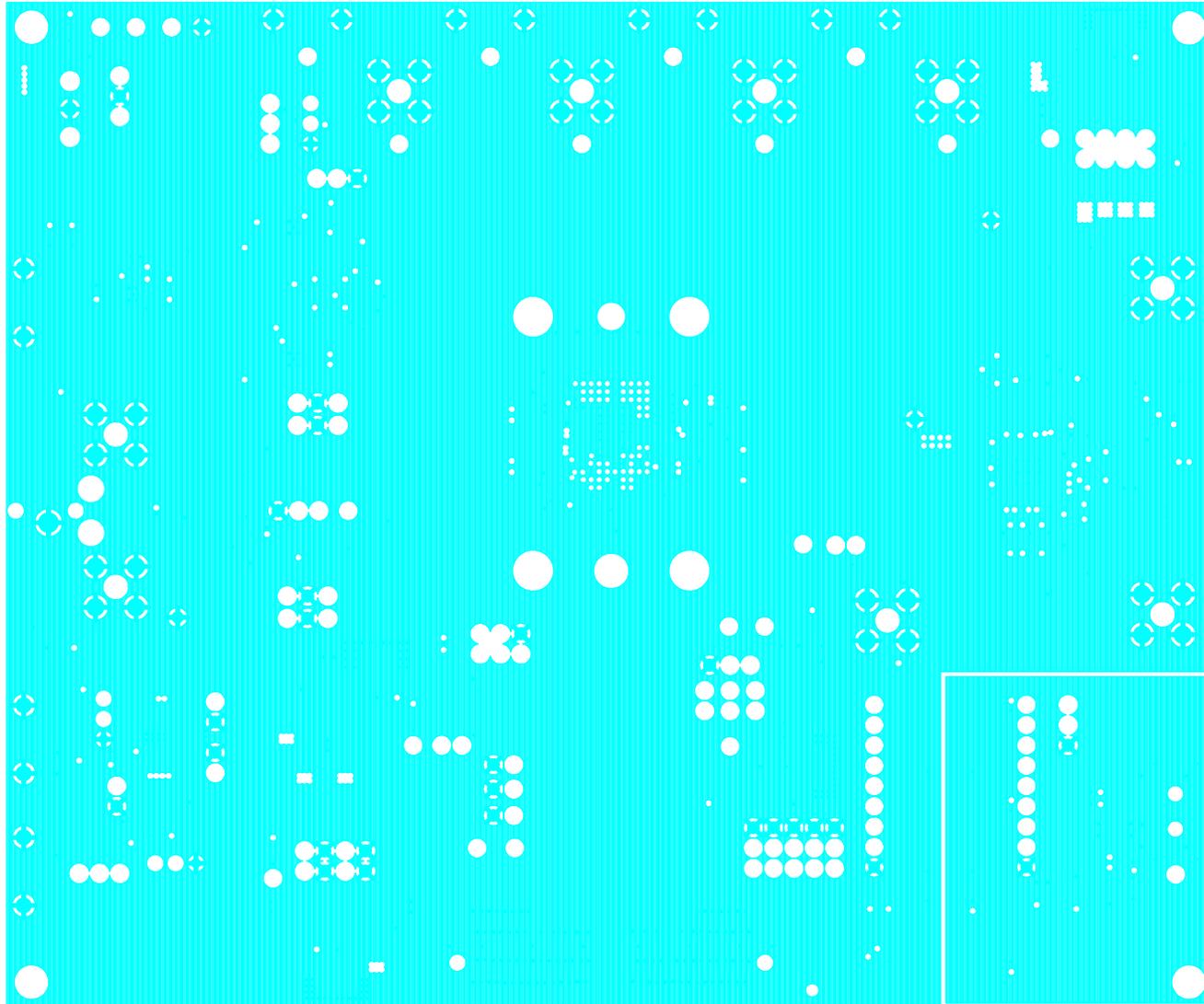
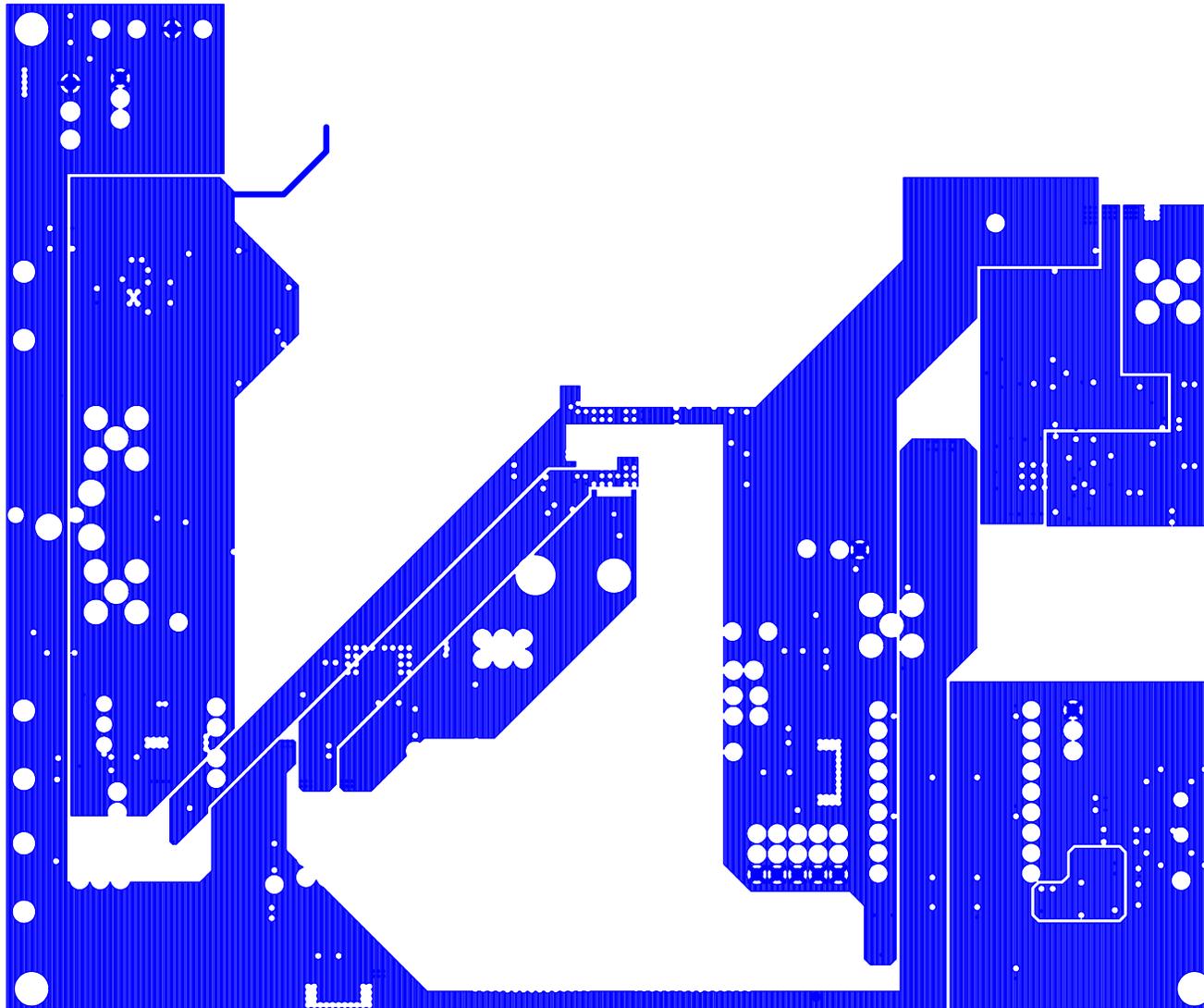
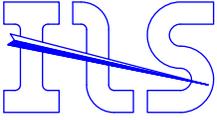


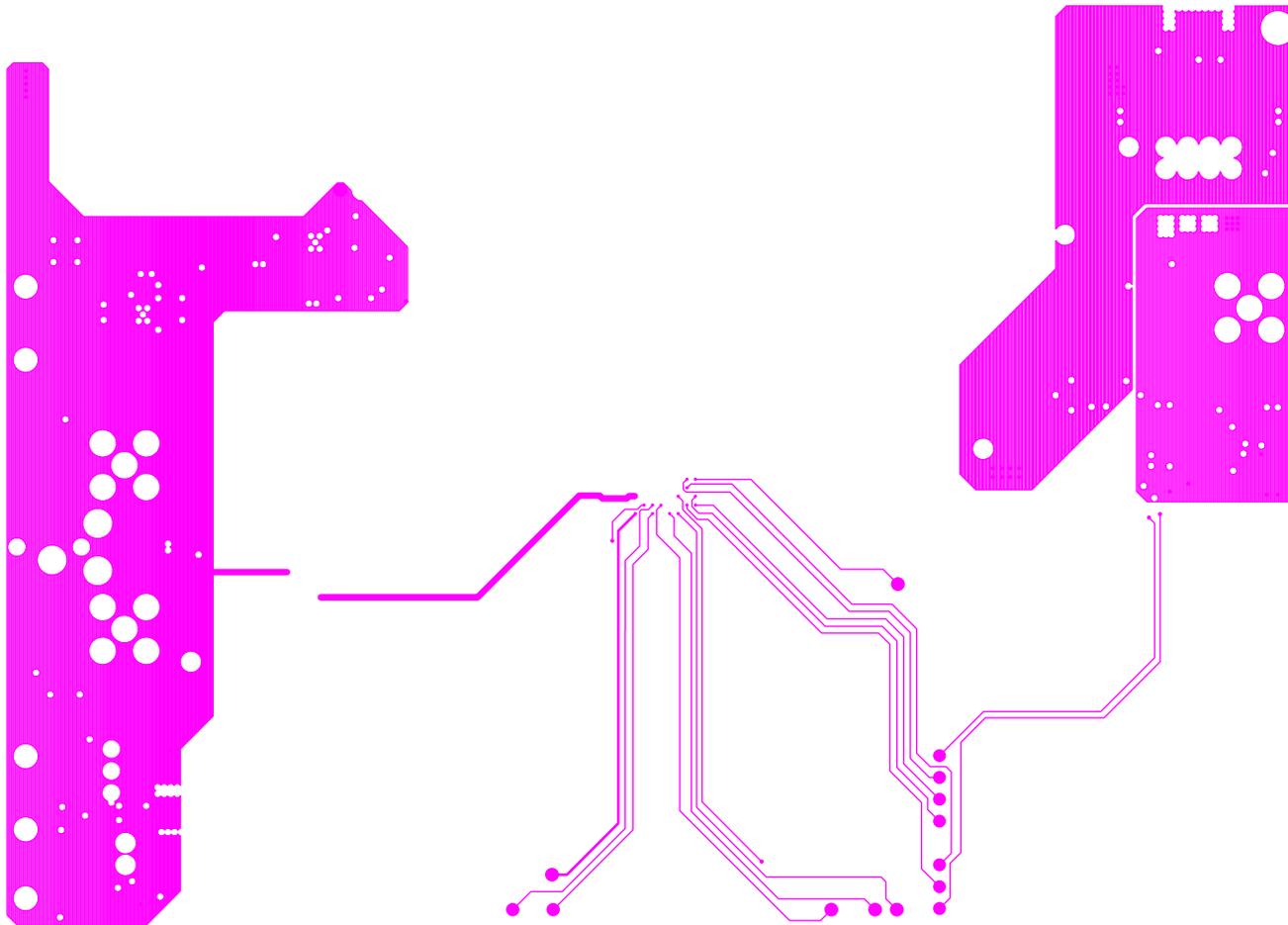
 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL	KSID: 13153	JOB NUMBER: 117905	
	BOARD NAME: AFE5809 EVM	LAYER DESCRIPTION: LAYER 1 - TOP SIDE		
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 01 of 13



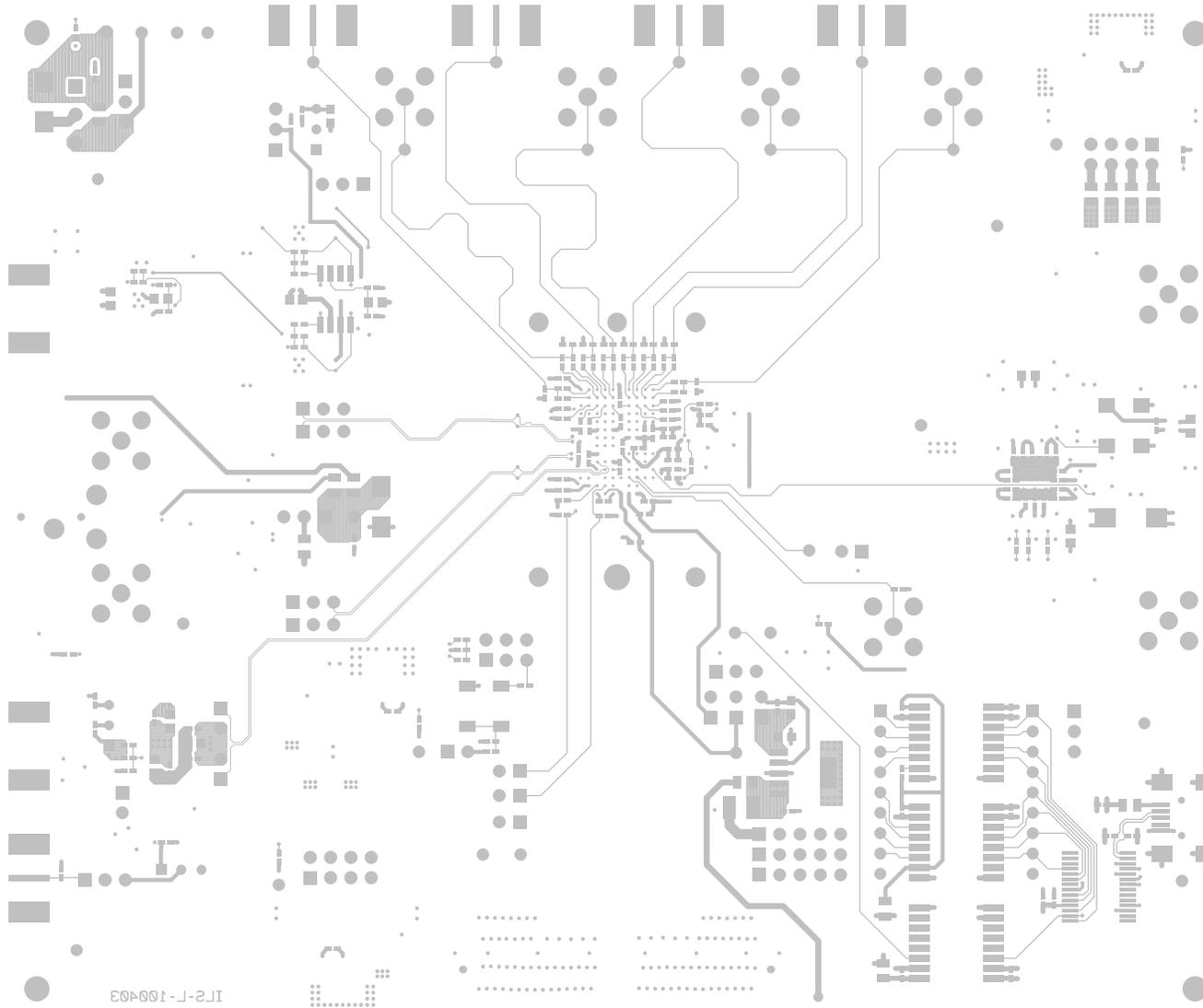
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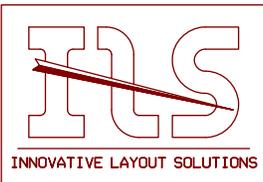
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	BOARD NAME: AFE5809 EVM		LAYER DESCRIPTION: LAYER 3 - SPLIT POWER PLANE	
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 03 of 13



 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL	KSID: 13153	JOB NUMBER: 117905	
	BOARD NAME: AFE5809 EVM	LAYER DESCRIPTION: LAYER 4 - SIGNAL 1		
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 04 of 13



	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL		KSID: 13153	JOB NUMBER: 117905
	BOARD NAME: AFE5809 EVM		LAYER DESCRIPTION: LAYER 6 - BOTTOM SIDE	
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 06 of 13



CUSTOMER:
TEXAS INSTRUMENTS - MEDICAL / HIREL

KSID:
13153

JOB NUMBER:
117905

BOARD NAME:
AFE5809 EVM

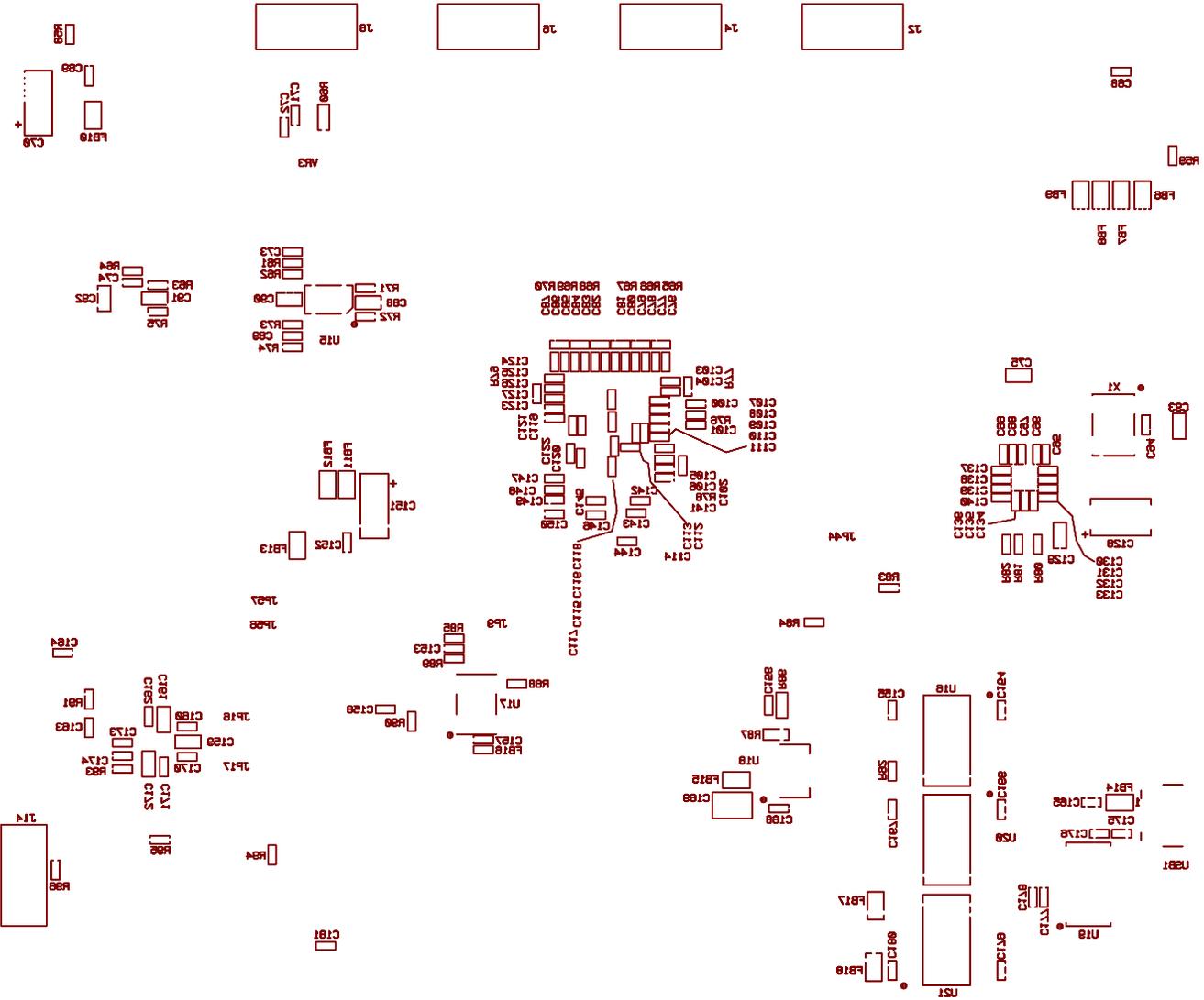
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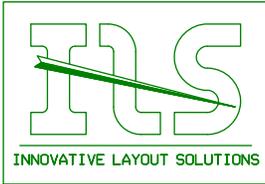
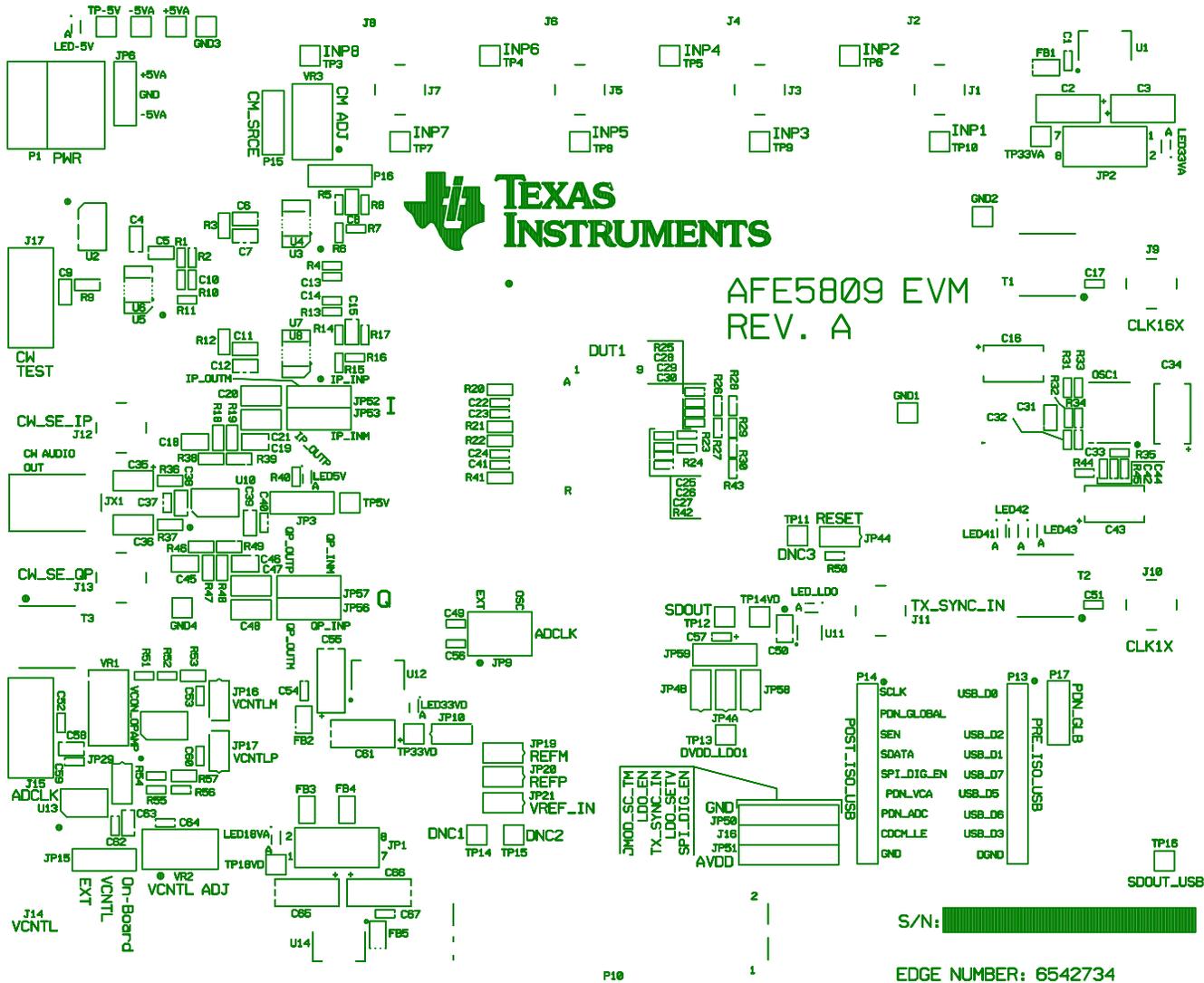
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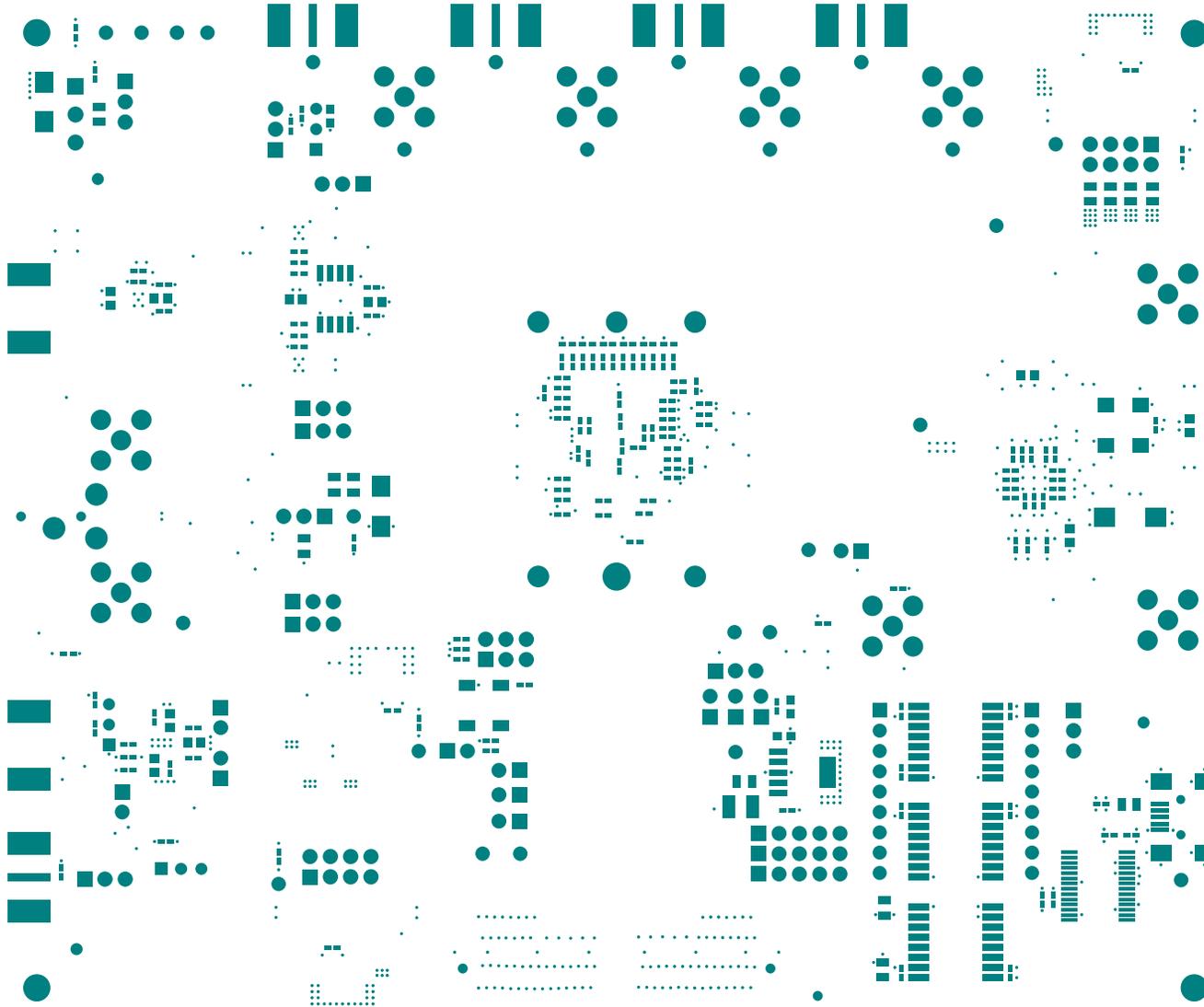
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SHEET NUMBER:
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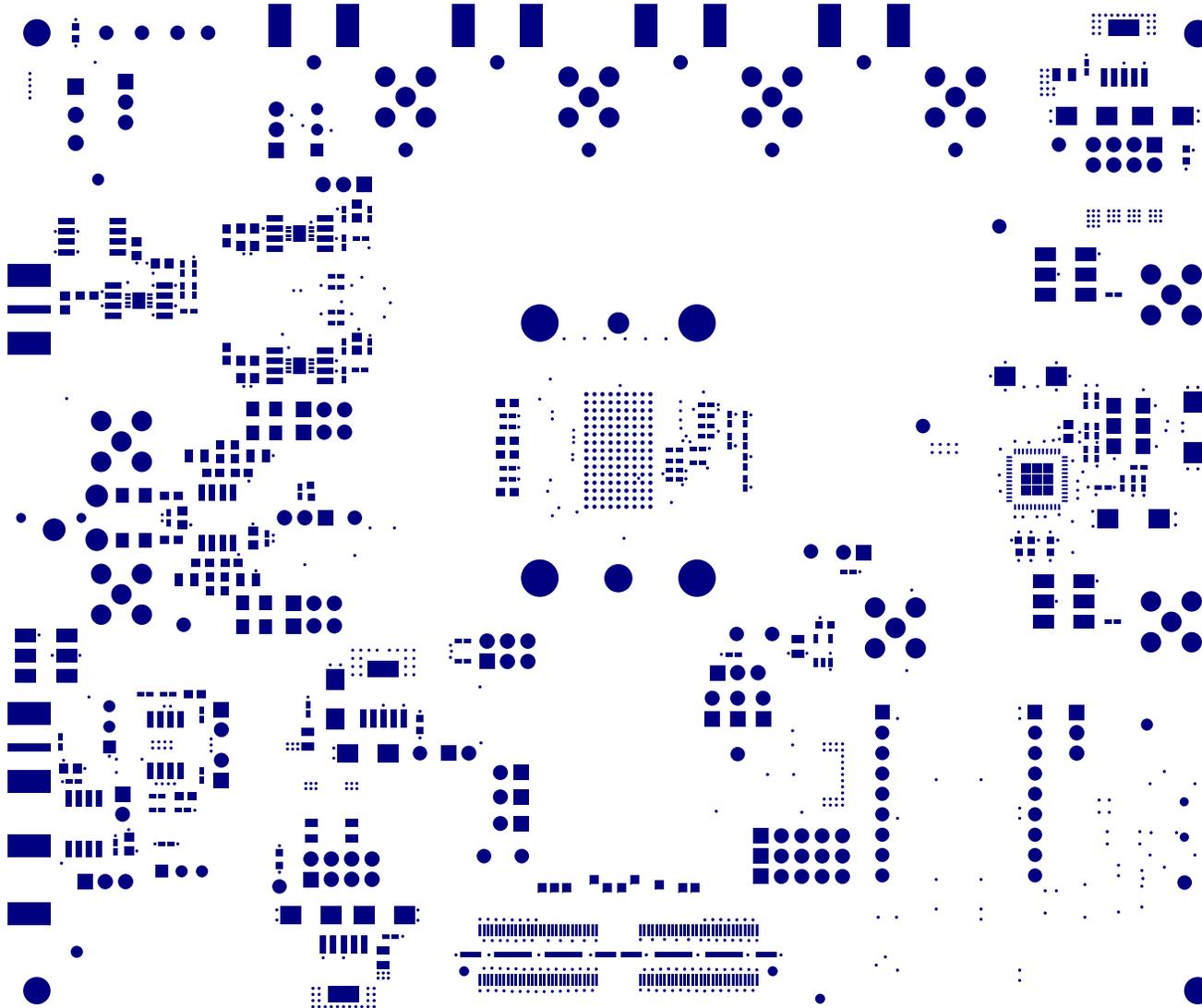


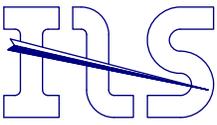


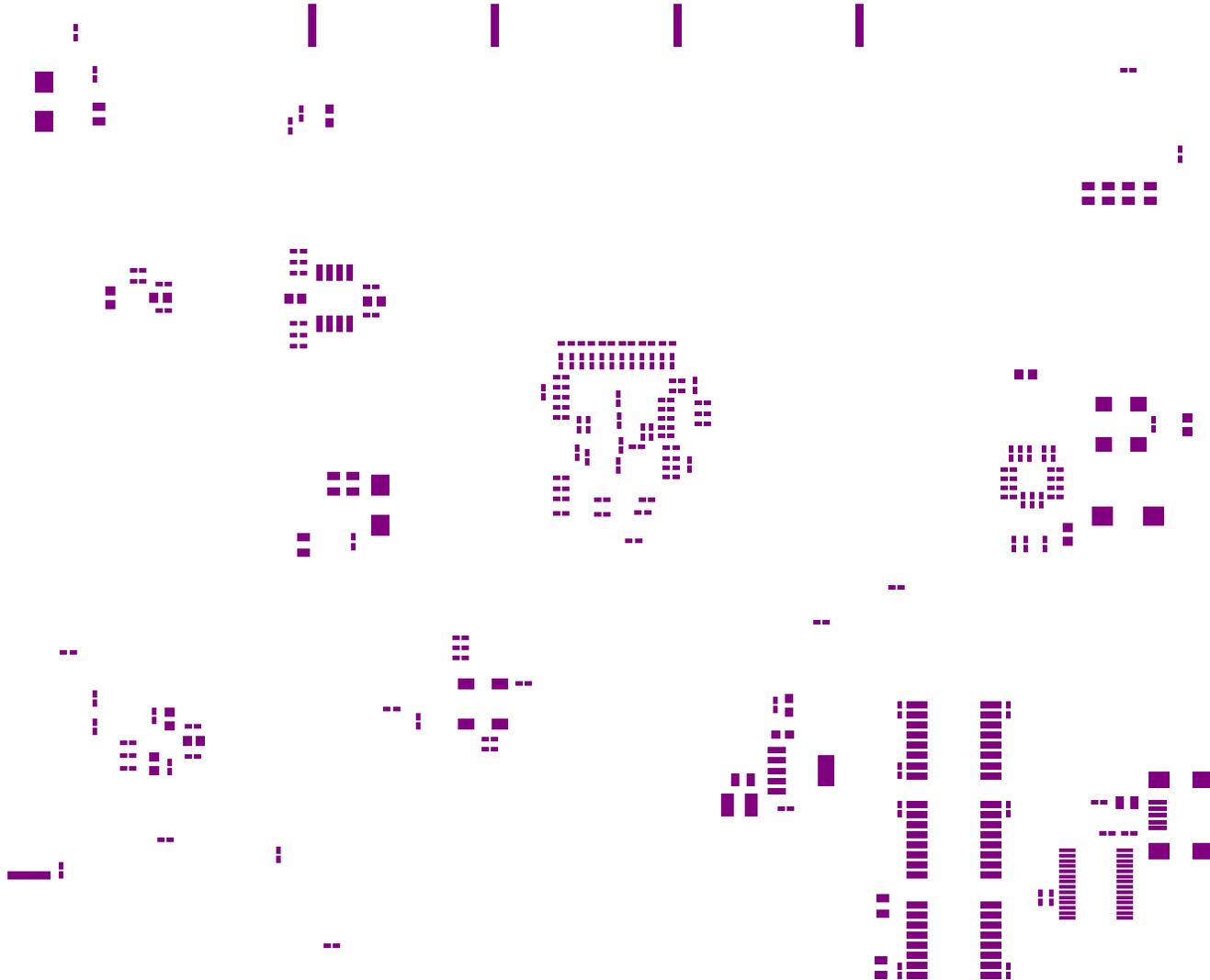
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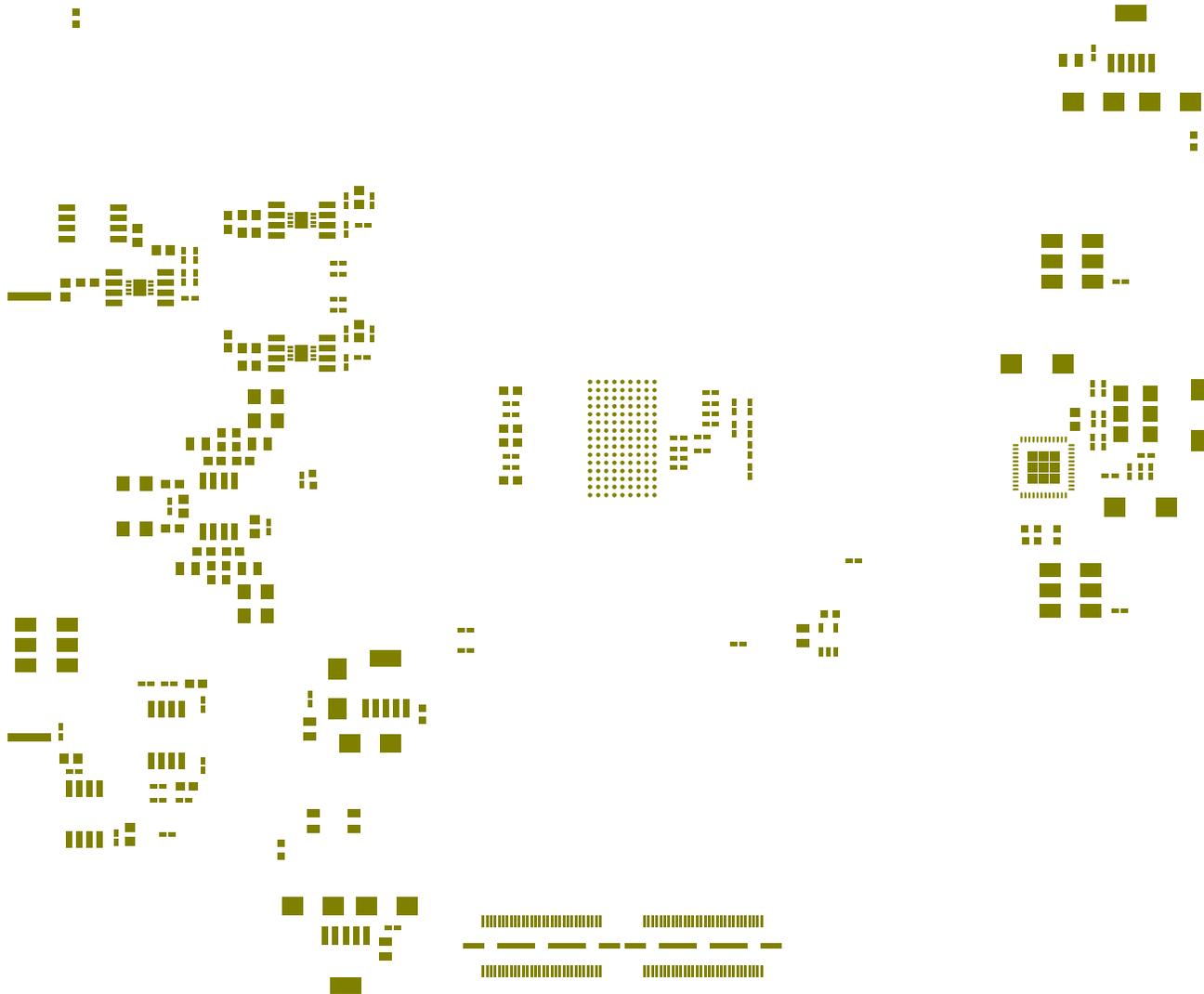
 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL		KSID: 13153	JOB NUMBER: 117905
	BOARD NAME: AFE5809 EVM		LAYER DESCRIPTION: SOLDERMASK - BOTTOM SIDE	
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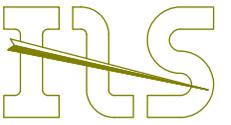


 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL		KSID: 13153	JOB NUMBER: 117905
	BOARD NAME: AFE5809 EVM		LAYER DESCRIPTION: SOLDERMASK - TOP SIDE	
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 07 of 13



 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL		KSID: 13153	JOB NUMBER: 117905
	BOARD NAME: AFE5809 EVM		LAYER DESCRIPTION: SOLDER PASTE - BOTTOM SIDE	
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12	SHEET NUMBER: 12 of 13



 INNOVATIVE LAYOUT SOLUTIONS	CUSTOMER: TEXAS INSTRUMENTS - MEDICAL / HIREL	KSID: 13153	JOB NUMBER: 117905
	BOARD NAME: AFE5809 EVM	LAYER DESCRIPTION: SOLDERPASTE - TOP SIDE	
	ILS PROJECT NUMBER: ILS-L-100403	BOARD REV: REV. A	RELEASE DATE: 110C12

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